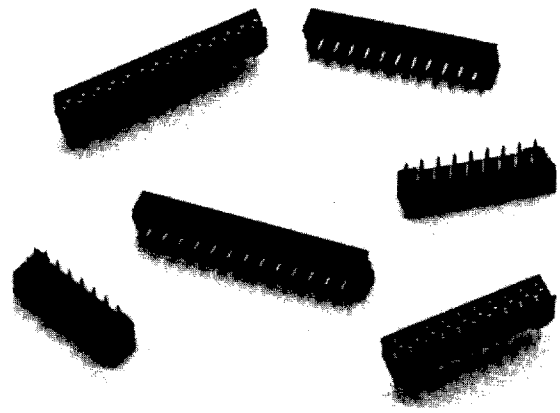


Stamped and Formed Sockets *Z.I.P. Staggered Stamped Dual Row Sockets*



Garry's low cost Z.I.P. sockets offer a reliable method of socketing Z.I.P. I.C. packages used in memory applications. Garry's design is end-to-end and side-by-side stackable for dense board layout.

- Dual beam construction.
- Closed bottom construction eliminates solder wicking.
- Garry's precise socket body dimensions permit end-to-end and side-by-side packaging on .100" spacing.

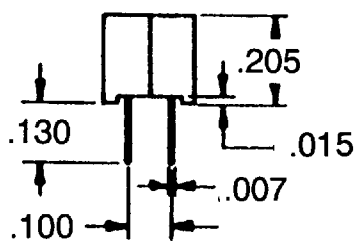
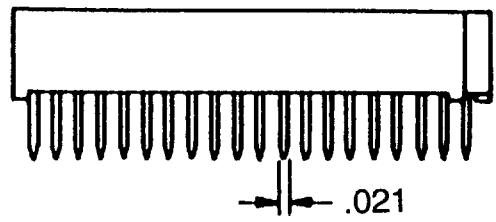
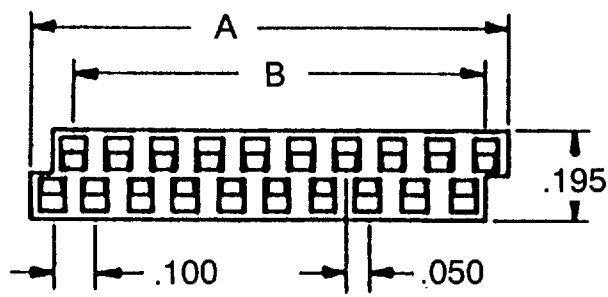
4.4

Materials:

Insulator:
Glass reinforced thermoplastic polyester, rated UL94V-0. Color: Black.

Contacts:
Phosphor bronze, tin lead plating.

Plating options and specifications are available by contacting either the Garry factory or your local representative.



XXXX - XX - X

SERIES-PIN COUNT				PIN PLATING	
	# OF PINS	A DIM.(in.)	B DIM.(in.)	T	Tin
7000-16	16	.849	.699		
7000-18	18	.949	.799		
7000-20	20	1.049	.899		
7000-24	24	1.249	1.099		
7000-28	28	1.449	1.399		